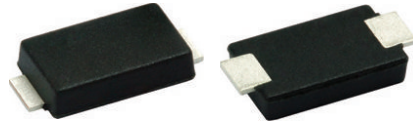


## Surface Mount ESD Capability Rectifiers

**SlimSMA**


Top View

Bottom View

**DO-221AC**

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	3.0 A
$V_{RRM}$	100 V, 200 V, 400 V, 600 V
$I_{FSM}$	40 A
$V_F$ at $I_F = 3.0$ A ( $T_A = 125$ °C)	0.86 V
$I_R$	10 $\mu$ A
$T_J$ max.	175 °C
Package	DO-221AC (SlimSMA)
Diode variations	Single die

### TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

### FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### MECHANICAL DATA

**Case:** DO-221AC (SlimSMA)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** Color band denotes the cathode end

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)						
PARAMETER	SYMBOL	SE30AFB	SE30AFD	SE30AFG	SE30AFJ	UNIT
Device marking code		S3B	S3D	S3G	S3J	
Maximum repetitive peak reverse voltage	$V_{RRM}$	100	200	400	600	V
Maximum DC forward current	$I_F^{(1)}$	3.0				A
	$I_F^{(2)}$	1.4				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	40				A
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +175				°C

#### Notes

(1) Mounted on 15 mm x 15 mm pad areas, 2 oz. FR4 PCB

(2) Free air, mounted on recommended copper pad area

ELECTRICAL CHARACTERISTICS ( $T_A = 25$ °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 1.5$ A	$T_A = 25$ °C	$V_F^{(1)}$	0.91	-	V
	$I_F = 3.0$ A			0.97	1.1	
	$I_F = 1.5$ A	$T_A = 125$ °C		0.79	-	
	$I_F = 3.0$ A			0.86	0.98	
Reverse current	Rated $V_R$	$T_A = 25$ °C	$I_R^{(2)}$	-	10	$\mu$ A
		$T_A = 125$ °C		13	100	
Typical reverse recovery time	$I_F = 0.5$ A, $I_R = 1.0$ A, $I_{rr} = 0.25$ A		$t_{rr}$	1.5	-	$\mu$ s
Typical junction capacitance	4.0 V, 1 MHz		$C_J$	19	-	pF

#### Notes

(1) Pulse test: 300  $\mu$ s pulse width, 1 % duty cycle

(2) Pulse test: Pulse width  $\leq$  40 ms



THERMAL CHARACTERISTICS ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	SYMBOL	SE30AFB	SE30AFD	SE30AFG	SE30AFJ	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	125				$^\circ\text{C/W}$
	$R_{\theta JM}^{(2)}$	12				

**Notes**

- (1) Free air, mounted on recommended PCB, 1 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient
- (2) Mounted on 15 mm x 15 mm pad areas, 2 oz. FR4 PCB;  $R_{\theta JM}$  - junction to mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	$C = 100\text{ pF}$ , $R = 1.5\text{ k}\Omega$	$V_C$	H3B	$> 8\text{ kV}$

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE30AFJ-M3/6A	0.032	6A	3500	7" diameter plastic tape and reel
SE30AFJ-M3/6B	0.032	6B	14 000	13" diameter plastic tape and reel
SE30AFJHM3/6A <sup>(1)</sup>	0.032	6A	3500	7" diameter plastic tape and reel
SE30AFJHM3/6B <sup>(1)</sup>	0.032	6B	14 000	13" diameter plastic tape and reel

**Note**

- (1) AEC-Q101 qualified

**RATINGS AND CHARACTERISTICS CURVES ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)**

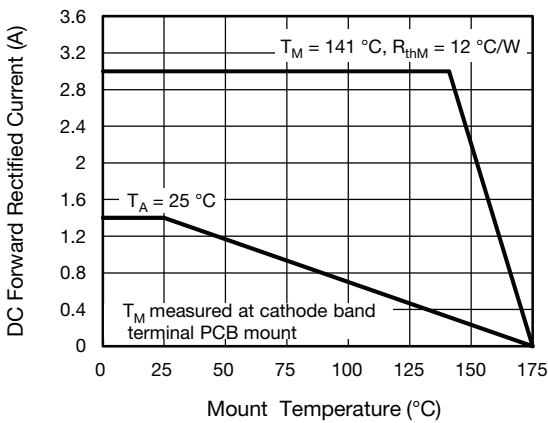


Fig. 1 - Maximum Forward Current Derating Curve

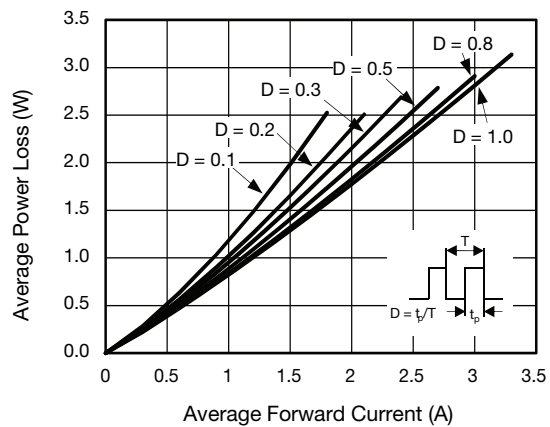


Fig. 2 - Forward Power Loss Characteristics



Fig. 3 - Typical Instantaneous Forward Characteristics

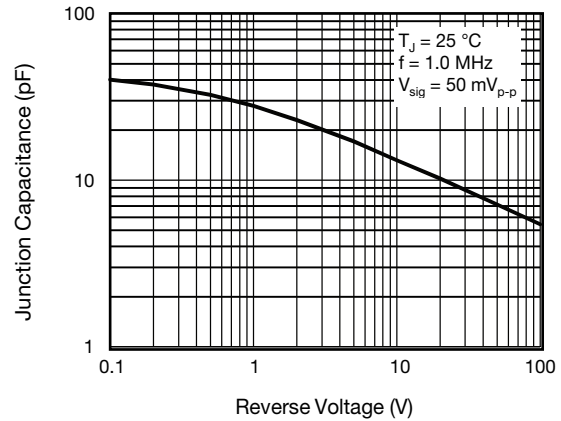


Fig. 5 - Typical Junction Capacitance



Fig. 4 - Typical Reverse Leakage Characteristics



Fig. 6 - Typical Junction Capacitance

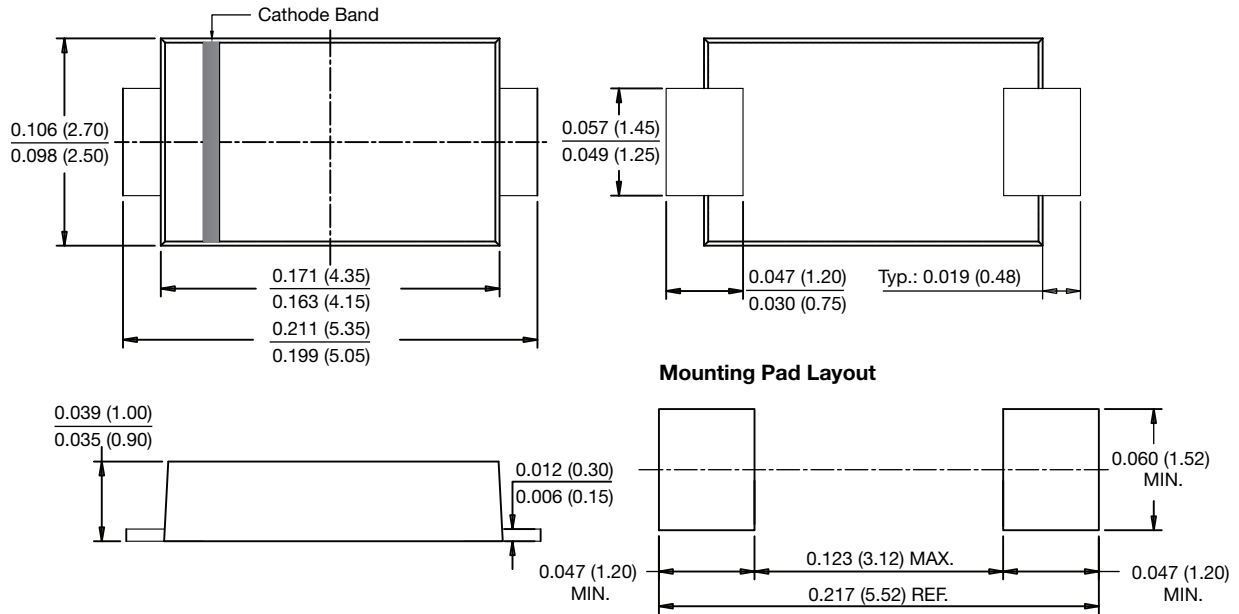


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas



## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

### DO-221AC (SlimSMA)





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- Консультации по применению компонента;
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- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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